

P-Channel 100-V (D-S) MOSFET

PRODU	CT SUMMARY		
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)
- 100	0.200 at V _{GS} = - 10 V	- 3.0	13.2 nC
	0.230 at V _{GS} = - 6 V	- 2.4	13.2110

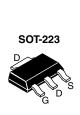
FEATURES

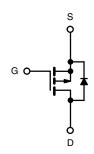
- TrenchFET® Power MOSFET
- 100% R_q and UIS Tested

ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

- Active Clamp in Intermediate DC/ DC Power Supplies
- H-Bridge High Side Switch for Lighting Application





P-Channel MOSFET

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	- 100	V	
Gate-Source Voltage		V _{GS}	± 20	v
	T _C = 25 °C		- 3.0	
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C		-2.1	
Continuous Diam Current (1) = 150 °C)	T _A = 25 °C	I _D	- 2 ^{a, b}	
	T _A = 70 °C		- 1.6 ^{a, b}	
Pulsed Drain Current		I _{DM}	- 12	A
Continuous Course Dunin Diada Current	T _C = 25 °C		- 4.9	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	- 2.5 ^{a, b}	
Avalanche Current	L = 0.1 mH	I _{AS}	- 15	
Single-Pulse Avalanche Energy		E _{AS}	11.25	mJ
	T _C = 25 °C		6.5	
Mariana Paran Dissination	T _C = 70 °C		4.8	w
Maximum Power Dissipation	T _A = 25 °C	P _D	3.1 ^{a, b}	vv
	T _A = 70 °C		2 ^{a, b}	
Operating Junction and Storage Temperature Rang	T _J , T _{stg}	- 55 to 150	°C	

Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s.

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{a, b}	t ≤ 10 s	R _{thJA}	33	40	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	17	21			

Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. Maximum under steady state conditions is 80 $^{\circ}\text{C/W}.$



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 100			V	
V _{DS} Temperature Coefficient	AVps/Tu			- 165		m\//°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA		- 6.6		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 2		- 4	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zava Cata Valtana Duain Courset	(III	V _{DS} = - 100 V, V _{GS} = 0 V			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 100 V, V _{GS} = 0 V, T _J = 55 °C			- 10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge -5 \text{ V}, V_{GS} = -10 \text{ V}$	- 8			Α	
	D	$V_{GS} = -10 \text{ V}, I_D = -3 \text{ A}$		0.200		Ω	
Drain-Source On-State Resistance ^a	$R_{DS(on)}$	V _{GS} = - 6 V, I _D = - 2 A		0.230			
Forward Transconductancea	9 _{fs}	V _{DS} = - 15 V, I _D = 3 A		12		S	
Dynamic ^b							
nput Capacitance C _{iss}			819				
Output Capacitance	C _{oss}	$V_{DS} = -35 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		51		pF	
Reverse Transfer Capacitance	C _{rss}			32			
Total Gate Charge		V _{DS} = - 50 V, V _{GS} = - 10 V, I _D = - 3 A		17.5	32	32	
	$Q_g = \frac{V_{DS} = 33 V_1 V_{GS} = 13 V_1 V_{D} = 3 V_1}{2}$		13.2	25			
Gate-Source Charge	Q _{as}	Q_{gs} $V_{DS} = -50 \text{ V}, V_{GS} = -6 \text{ V}, I_D = -3 \text{ A}$		3.4		nC	
Gate-Drain Charge	Q _{gd}			6.4			
Gate Resistance	R _q	f = 1 MHz		6.1	9.2	Ω	
Turn-On Delay Time	t _{d(on)}			10	20		
Rise Time	t _r	$V_{DD} = -50 \text{ V}, R_{L} = 25 \Omega$		55	95	1	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong -3 \text{ A}, V_{GEN} = -6 \text{ V}, R_q = 1 \Omega$		20	40		
Fall Time	t _f	Ŭ		15	30	1	
Turn-On Delay Time	t _{d(on)}			11	18	ns	
Rise Time	t _r	$V_{DD} = -50 \text{ V}, R_{L} = 25 \Omega$		18	32		
Turn-Off DelayTime	t _{d(off)}	$I_D \cong -3 \text{ A}, V_{GEN} = -10 \text{ V}, R_a = 1 \Omega$		32	58		
Fall Time	t _f	3		20	35	1	
Drain-Source Body Diode Characterist	•				1		
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 13		
Pulse Diode Forward Current ^a	I _{SM}	-			- 15	Α	
Body Diode Voltage	V _{SD}	I _S = - 3 A		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}	-		65	90	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			180	270	nC	
Reverse Recovery Fall Time	t _a	$I_F = -3 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		45	-		
Reverse Recovery Rise Time	t _b			20		ns	

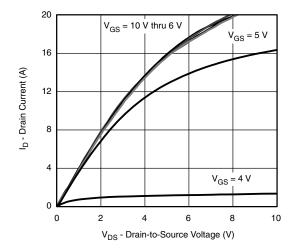
Notes:

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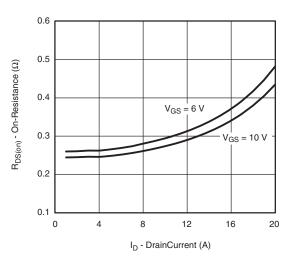
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

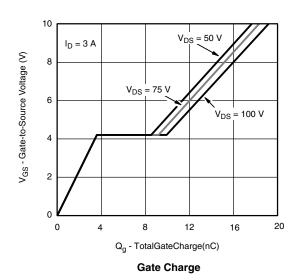


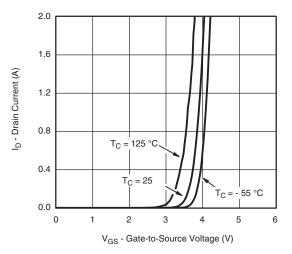


Output Characteristics

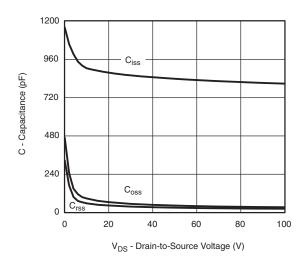


On-Resistance vs. Drain Current and Gate Voltage

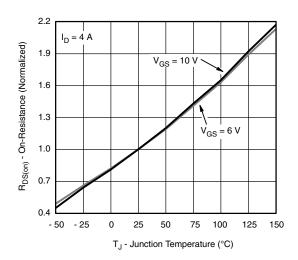




Transfer Characteristics

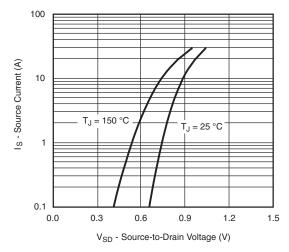


Capacitance

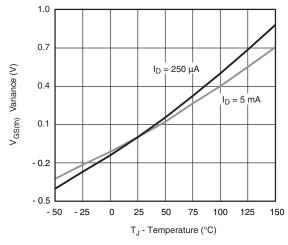


On-Resistance vs. Junction Temperature

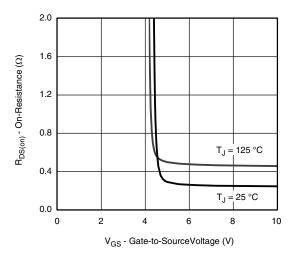




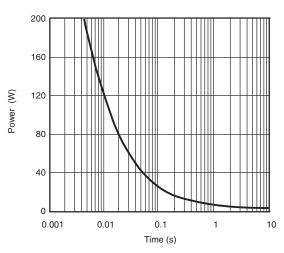
Source-Drain Diode Forward Voltage



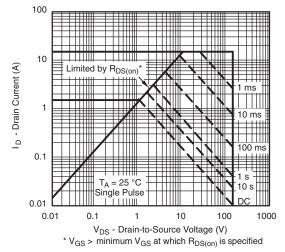
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage

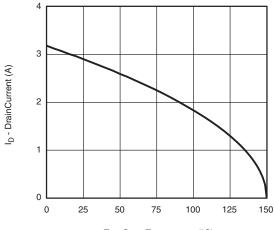


Single Pulse Power, Junction-to-Ambient



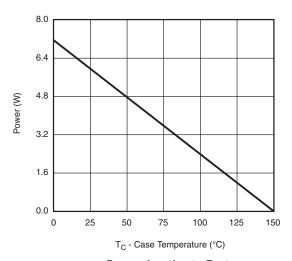
Safe Operating Area, Junction-to-Ambient



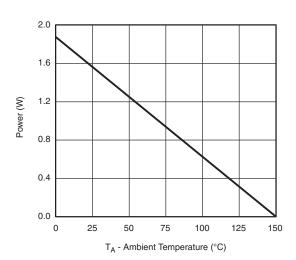


T_C - Case Temperature (°C)

Current Derating*



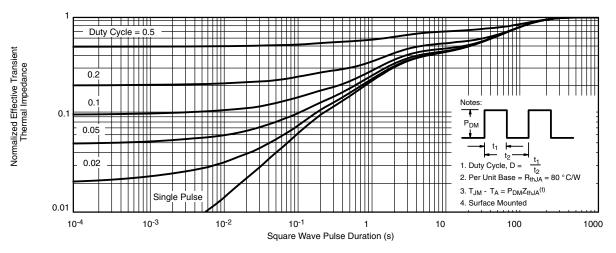
Power, Junction-to-Foot



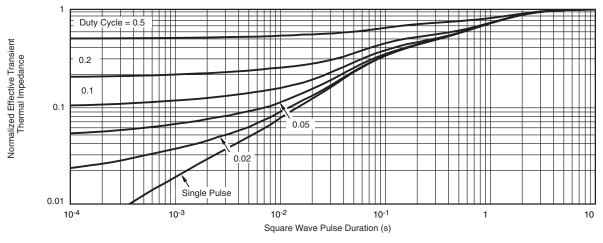
Power, Junction-to-Ambient

^{*} The power dissipation P_D is based on $T_{J(max.)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





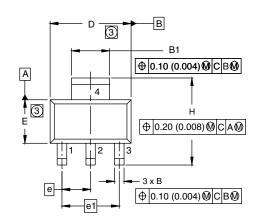
Normalized Thermal Transient Impedance, Junction-to-Ambient

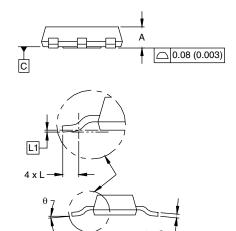


Normalized Thermal Transient Impedance, Junction-to-Foot



SOT-223 (HIGH VOLTAGE)





DIM.	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
Α	1.55	1.80	0.061	0.071
В	0.65	0.85	0.026	0.033
B1	2.95	3.15	0.116	0.124
С	0.25	0.35	0.010	0.014
D	6.30	6.70	0.248	0.264
E	3.30	3.70	0.130	0.146
е	2.30 BSC		0.090	5 BSC
e1	4.60 BSC		0.181	BSC
Н	6.71	7.29	0.264	0.287
L	0.91	-	0.036	-
L1	0.061 BSC		0.0024	4 BSC
θ	-	10'	-	10'

ECN: S-82109-Rev. A, 15-Sep-08

DWG: 5969

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension do not include mold flash.
- 4. Outline conforms to JEDEC outline TO-261AA.

服务热线:400-655-8788

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